REMARKS

Favorable reconsideration of this application is respectfully requested.

The outstanding Office Action indicates the Information Disclosure Statement (IDS) filed May 3, 2005 was not considered as it fails to comply with 37 C.F.R. § 1.98(a)(3) by not including a concise explanation of the relevance of the cited references. Applicants traverse that position and respectfully submit that IDS must be considered on its merits.

The IDS of May 3, 2005 was submitted based on a foreign search report, and that IDS included an English version of the search report, which applicants submit clearly provides a statement of relevancy of the cited art on the search report. Thereby, that IDS of May 3, 2005 was proper under 35 U.S.C. § 198(a)(3) and must be considered.

The specification is herein amended to include certain suggested headings under United States practice and to clarify certain language. No new matter is believed to be added.

Claims 14-25 are pending in this application. Claims 14-25 were rejected under 35 U.S.C. § 112, second paragraph. Claims 14, 16-21, and 23-24 were rejected under 35 U.S.C. § 102(e) as anticipated by U.S. patent application publication 2003/0111447 A1 to Corkum et al. (herein "Corkum"). Claim 25 was rejected under 35 U.S.C. § 102(b) as anticipated by WO 00/03289, English translation U.S. patent 6,337,758 B1, to Beteille et al. (herein "Beteille"). Claim 15 was rejected under 35 U.S.C. § 103(a) as unpatentable over Corkum as applied to claims 14, 16-21, and 23-24, and further in view of U.S. patent application publication 2002/0046998 A1 to Hackel et al. (herein "Hackel"). Claim 22 was rejected under 35 U.S.C. § 103(a) as unpatentable over Corkum as applied to claims 14, 16-21, and 23-24, and further in view of U.S. patent 7,027,155 B2 to Cordingley et al. (herein "Cordingley"). Those rejections are traversed by the present response as discussed next.

Addressing first the rejection of claims 14-25 under 35 U.S.C. § 112, second paragraph, claims 14 and 20 are herein amended to delete or clarify the language noted as

unclear. The amendments to claims 14 and 20 are believed to address the rejections thereto under 35 U.S.C. § 112, second paragraph.

Addressing now the rejection of claims 14, 16-21, and 23-24 under 35 U.S.C. § 102(e) as anticipated by Corkum, the further rejection of claim 15 further in view of Hackel, and the further rejection of claim 22 further in view of Cordingley, those rejections are traversed by the present response.

Independent claim 14 is herein amended to clarify the claimed method eliminates a "pinhole" defect. Independent claim 14 also clarifies the pinhole defect is ablated "through at least one of the first or second substrates". The above-noted features are believed to be clear from the original specification and thus not add any new matter. Further, applicants respectfully submit such features clarified in the claims are neither taught nor suggested by the applied art.

The above-noted rejections rely on Corkum as the primary reference, but applicants respectfully submit Corkum differs from the claims as written. Corkum is directed to a method and apparatus for repairing defects in an electric or opto-electronic component by utilizing a laser pulse.

Applicants respectfully submit Corkum differs from the claims as written as first Corkum does not disclose or suggest eliminating a "pinhole defect" that lies within a laminate between first and second substrates. For example in Figure 7a Corkum shows a short-circuit defect can be eliminated by a pulsed laser. Applicants submit in Corkum such a short-circuit is not a "pinhole defect", and further the structure being processed in Corkum is not "a laminate formed from at least a first substrate and from at least a second substrate". Thereby, such features clarified in the claims are believed to distinguish over Corkum.

Moreover, as also clarified in the claims, the pinhole defect is ablated "through at least one of the first or second substrates". Applicants submit that feature is also neither

taught nor suggested by Corkum. For example in Figures 7a and 7b Corkum disclose a substrate as a bottommost surface, but in Corkum the pulsed laser is provided from an opposite end than the substrate end to address the short circuit defect. In Corkum the noted short circuit defect is ***not*** ablated "through at least one of the first or second substrates".

Thereby, Corkum fails to disclose or suggest that further feature now positively recited in independent claim 14.

Moreover, applicants respectfully submit no disclosures in Hackel or Cordingley were cited with respect to the above-noted features, and no disclosures in Hackel or Cordingley are believed to cure the above-noted deficiencies in Corkum.

In view of the foregoing comments, applicants respectfully submit amended independent claim 14, and claims 15-24 dependent therefrom, patentably distinguish over the applied art.

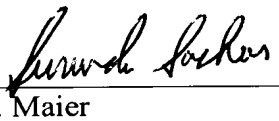
Addressing now the rejection of claim 25 under 35 U.S.C. § 102(b) as anticipated by Beteille, that rejection is traversed by the present response.

Independent claim 25 now clarifies the "electrochemical device including a pinhole defect ablated at its peripheral region". That feature is believed to clarify a structural element of the claimed glazing. Such a feature is believed to also distinguish over Beteille as applicants respectfully submit Beteille does not disclose or suggest a glazing including such a pinhole defect that has been ablated at is peripheral region. Thereby, amended independent claim 25 as currently written is believed to also be patentable over the applied art.

As no other issues are pending in this application, it is respectfully submitted that the present application is now in condition for allowance, and it is hereby respectfully requested that this case be passed to issue.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,
MAIER & NEUSTADT, P.C.



Gregory J. Maier
Attorney of Record
Registration No. 25,599

Surinder Sachar
Registration No. 34,423

Customer Number
22850

Tel: (703) 413-3000
Fax: (703) 413 -2220
(OSMMN 06/04)

I:\ATTY\SNS\26s\267380\267380US-AM DUE 12-05-08.DOC